



Product Change Notification

Change Notification #: 115572 - 00

Change Title: Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x16 Low Profile 100HFA016LS,

Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x16 Standard 100HFA016FS,

Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x8 Low Profile 100HFA018LS,

Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x8 Standard 100HFA018FS,

PCN 115572-00, Product Design,

Manufacturing Process Change to Remove Unused Test Header

Date of Publication: June 12, 2017

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

| | |
|---|--------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | Jun 30, 2017 |
|---|--------------|

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

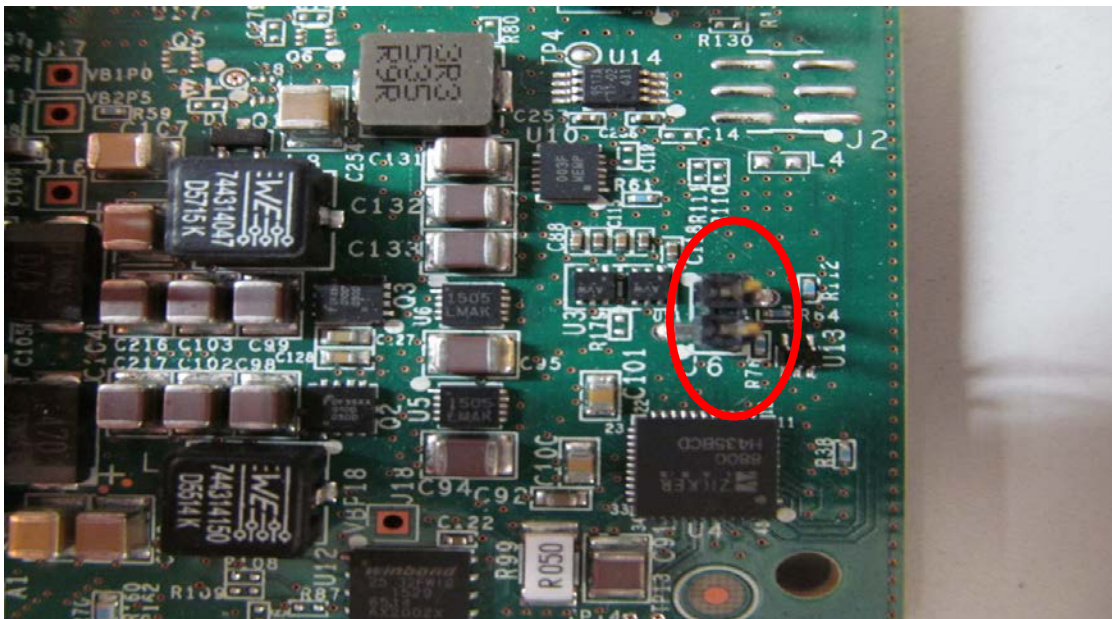
| Affected Product Code | Product Description |
|-----------------------|---|
| 100HFA016LS | Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x16 Low Profile 100HFA016LS |
| 100HFA016FS | Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x16 Standard 100HFA016FS |
| 100HFA018LS | Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x8 Low Profile 100HFA018LS |
| 100HFA018FS | Intel® Omni-Path Host Fabric Interface Adapter 100 Series 1 Port PCIe x8 Standard 100HFA018FS |

Overview of Changes:

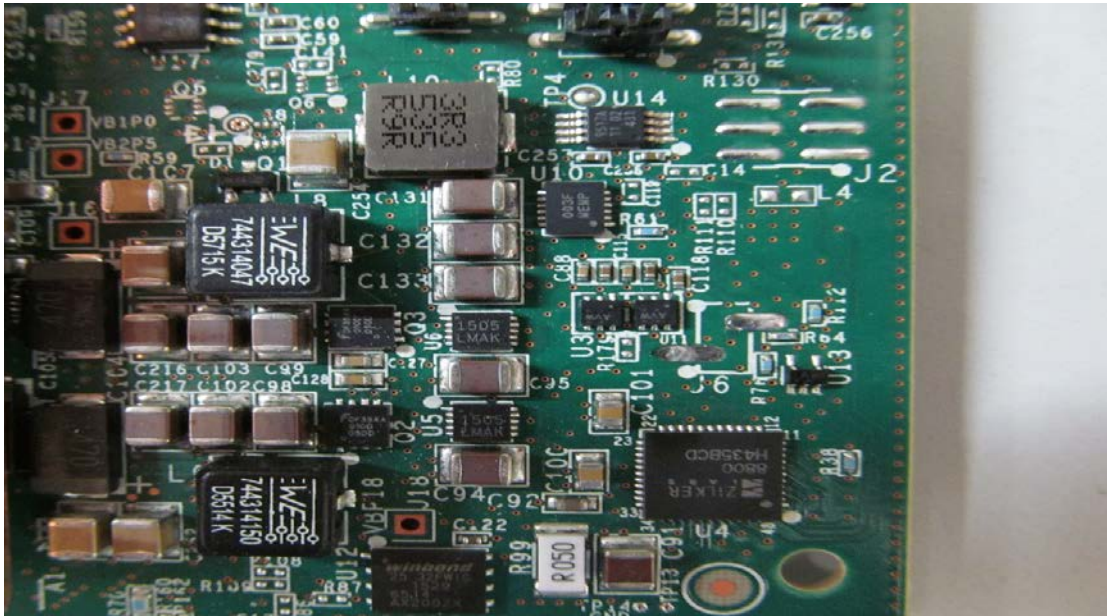
Manufacturing Process Change to Remove Unused Test Header

Product Change Details:

The J6 header will be removed from the right side of the HFI adapters as a manufacturing process improvement. This component is located on the topside of the adapter at the far end - away from the bracket - per the pictures below. This change is benign to product fit and function since this manufacturing header is no longer used. This header is not used by the customer. The planned change to manufacturing process has been evaluated to ensure no quality, reliability or functional impacts to our customers.



Before - J6 installed



After - J6 removed

Customer Impact of Change and Recommended Action:

This change does not impact fit or function of the adapter and no customer action is required.

Please contact your local Intel Field Sales Representative if you have any questions about this change.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

| Product Code | MM# | Pre Change MM# Rev | Post Change MM# Rev | Pre Change TA | Pre Change CA | Pre Change PBA | Post Change TA | Post Change CA | Post Change PBA |
|--------------|--------|--------------------|---------------------|---------------|---------------|----------------|----------------|----------------|-----------------|
| 100HFA016LS | 948159 | 14 | 15 | J10549-023 | J10548-023 | J10547-021 | J10549-024 | J10548-024 | J10547-022 |
| 100HFA016FS | 945671 | 04 | 05 | J29320-004 | J29321-004 | J10547-021 | J29320-005 | J29321-005 | J10547-022 |
| 100HFA018LS | 945670 | 10 | 11 | J12508-013 | J12507-013 | J12506-010 | J12508-014 | J12507-014 | J12506-011 |
| 100HFA018FS | 945672 | 03 | 04 | J31082-003 | J31081-003 | J12506-010 | J31082-004 | J31081-004 | J12506-011 |

PCN Revision History:

Date of Revision:

June 12, 2017

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

115572 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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